

Box Patent Application  
Assistant Commissioner for Patents  
Washington, D.C. 20231

Date: 05/10/01

Applicant: Charles W.C. Lin  
Title: BUMBLESS FLIP CHIP ASSEMBLY WITH SOLDER VIA  
Express Mail No: EK770854597US  
Atty Docket No.: P002-2

J1000 U.S. PTO  
09/852824

05/10/01

Documents Enclosed:

Transmittal (2 pages)

Prior Application

Specification (8 pages), Claims (3 pages), Abstract (1 page), Drawings (4 sheets)

Prior Declaration (2 pages)

Preliminary Amendment (11 pages)

Substitute Specification (cover sheet plus 8 pages)

Substitute Specification -Changes Shown (cover sheet plus 10 pages)

Submission of Proposed Drawing Amendment for Approval by Examiner (2 pages)

Information Disclosure Statement (2 pages)

PTO-1449 (9 pages)

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Assistant Commissioner for Patents  
Washington, D.C. 20231

Date: 01/28/02

Applicant: Charles W.C. Lin  
Title: BUMBLESS FLIP CHIP ASSEMBLY WITH SOLDER VIA  
Serial No.: 09/852,824  
Filed: May 10, 2001  
Docket No.: P002-2

Documents Enclosed:

Information Disclosure Statement (2 pages)

PTO-1449 (1 page)

Seven References

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